# 74HC299

## 8-bit universal shift register; 3-state

Rev. 6 — 11 May 2021

**Product data sheet** 

### 1. General description

The 74HC299 is an 8-bit universal shift register with 3-state outputs. It contains eight edge-triggered D-type flip-flops and the interstage logic necessary to perform synchronous shift-right, shift-left, parallel load and hold operations. The type of operation is determined by the mode select inputs S0 and S1. Pins I/O0 to I/O7 are flip-flop 3-state buffer outputs which allow them to operate as data inputs in parallel load mode. The serial outputs Q0 and Q7 are used for expansion in serial shifting of longer words. A LOW signal on the asynchronous master reset input  $\overline{\text{MR}}$  overrides the Sn and clock CP inputs and resets the flip-flops. All other state changes are initiated by the rising edge of the clock pulse. Inputs can change when the clock is either state, provided that the recommended set-up and hold times are observed. A HIGH signal on the 3-state output enable inputs  $\overline{\text{OE}}1$  or  $\overline{\text{OE}}2$  disables the 3-state buffers and the I/On outputs assume a high-impedance OFF-state. In this condition, the shift, hold, load and reset operations can still occur. The 3-state buffers are also disabled by HIGH signals on both S0 and S1, when in preparation for a parallel load operation. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{\text{CC}}$ .

#### 2. Features and benefits

- · CMOS input levels
- · Multiplexed inputs/outputs provide improved bit density
- · Four operating modes:
  - Shift left
  - Shift right
  - · Hold (store)
  - Load data
- Operates with output enable or at high-impedance OFF-state
- · 3-state outputs drive bus lines directly
- · Cascadable for n-bit word lengths
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

# 3. Ordering information

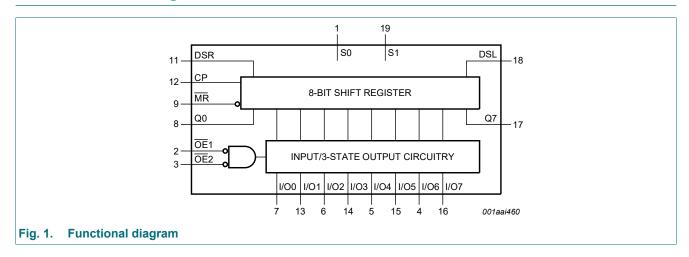
Table 1. Ordering information

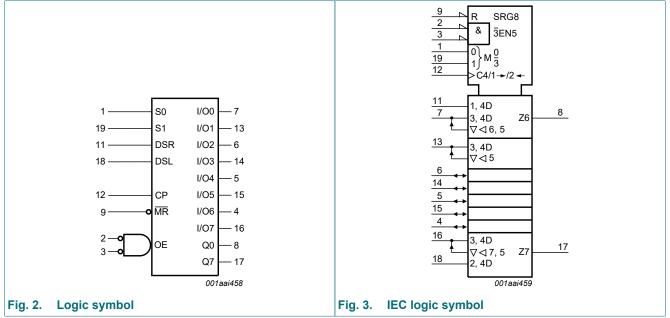
Type number	Package			
	Temperature range	Name	Description	Version
74HC299D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1



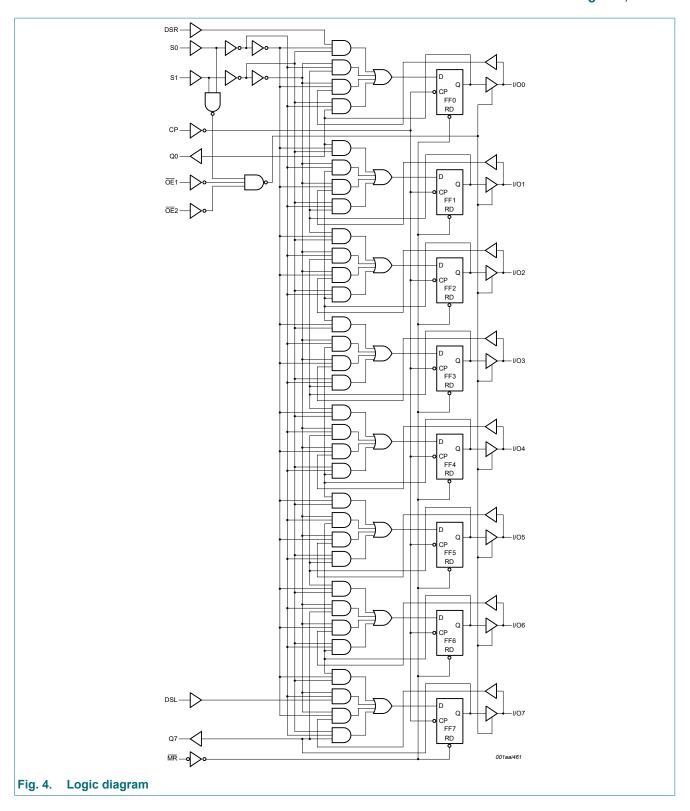
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# 4. Functional diagram





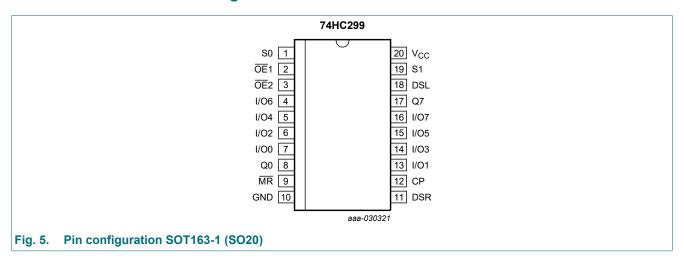
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# 5. Pinning information

#### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

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Symbol	Pin	Description
S0, S1	1, 19	mode select input
OE1, OE2	2, 3	3-state output enable input (active LOW)
I/O0, I/O1, I/O2, I/O3, I/O4, I/O5, I/O6, I/O7	7, 13, 6, 14, 5, 15, 4, 16	parallel data input or 3-state parallel output (bus driver)
Q0, Q7	8, 17	serial output (standard output)
MR	9	asynchronous master reset input (active LOW)
GND	10	ground (0 V)
DSR	11	serial data shift-right input
СР	12	clock input (LOW to HIGH, edge-triggered)
DSL	18	serial data shift-left input
V <sub>CC</sub>	20	positive supply voltage

# 6. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ \uparrow = LOW \ to \ HIGH \ CP \ transition; \ X = don't \ care.$ 

Input				Response
MR	S1	S0	СР	
L	Х	Х	Х	asynchronous reset; Q0 to Q7 = LOW
Н	Н	Н	<b> </b>	parallel load; I/On → Qn
Н	L	Н	<b>↑</b>	shift right; DSR $\rightarrow$ Q0, Q0 $\rightarrow$ Q1, etc.
Н	Н	L	<b>1</b>	shift left; DSL $\rightarrow$ Q7, Q7 $\rightarrow$ Q6, etc.
Н	L	L	Х	hold

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## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	[1]	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$				
		standard outputs		-	±25	mA
		bus driver outputs		-	±35	mA
I <sub>CC</sub>	supply current	standard outputs		-	50	mA
		bus driver outputs		-	70	mA
I <sub>GND</sub>	ground current	standard outputs		-50	-	mA
		bus driver outputs		-70	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 8. Recommended operating conditions

#### **Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	ns/V

<sup>[2]</sup> For SOT163-1 (SO20) package: Ptot derates linearly with 12.3 mW/K above 109 °C.

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## 9. Static characteristics

**Table 6. Static characteristics** 

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$								
	voltage	all outputs								
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		standard outputs								
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
		bus driver outputs								
		$I_{O}$ = -6.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -7.8 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level output	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	voltage	all outputs								
		$I_{O} = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 4.5 $V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \mu A; V_{CC} = 6.0 V$	-	0	0.1	-	0.1	-	0.1	V
		standard outputs								
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	_	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
		bus driver outputs								
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
C <sub>I/O</sub>	input/output capacitance		-	10	-	-	-	-	-	pF

#### 8-bit universal shift register; 3-state

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$ [1]	-	120	-	-	-	-	-	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:  $f_i = \text{input frequency in MHz}$ ;

f<sub>o</sub> = output frequency in MHz;

 $\sum$  (C<sub>L</sub> x V<sub>CC</sub>  $^2$  x f<sub>o</sub>) = sum of outputs.

C<sub>L</sub> = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V.

# 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

GND (ground = 0 V); for test circuit, see Fig. 10.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>pd</sub>	propagation delay	CP to Q0, Q7; see <u>Fig. 6</u> [1]								
		V <sub>CC</sub> = 2.0 V	-	66	200	-	250	-	300	ns
		V <sub>CC</sub> = 4.5 V	-	24	40	-	50	-	60	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	19	34	-	43	-	51	ns
		CP to I/On; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	-	66	200	-	250	-	300	ns
		V <sub>CC</sub> = 4.5 V	-	24	40	-	50	-	60	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	19	34	-	43	-	51	ns
		MR to Q0, Q7 or I/On; [2] see Fig. 7								
		V <sub>CC</sub> = 2.0 V	-	66	200	-	250	-	300	ns
		V <sub>CC</sub> = 4.5 V	-	24	40	-	50	-	60	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	19	34	-	43	-	51	ns
t <sub>t</sub>	transition time	bus driver (I/On); see Fig. 6 [3]								
		V <sub>CC</sub> = 2.0 V	-	14	60	-	75	-	90	ns
		V <sub>CC</sub> = 4.5 V	-	5	12	-	15	-	18	ns
		V <sub>CC</sub> = 6.0 V	-	4	10	-	13	-	15	ns
		standard (Q0, Q7); see Fig. 6								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns

### 8-bit universal shift register; 3-state

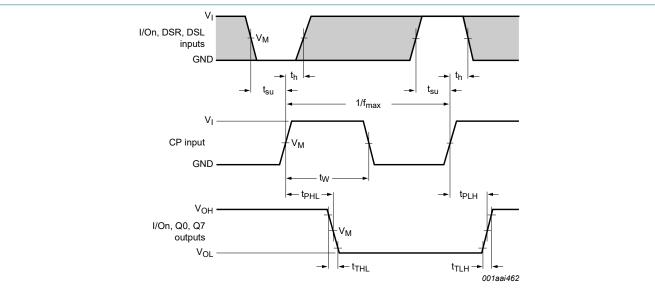
Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	_
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	80	17	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	17	-	20	-	ns
		MR LOW; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	80	19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
t <sub>PZH</sub>	OFF-state to HIGH	OEn to I/On; see Fig. 9	[4]							
	propagation delay	V <sub>CC</sub> = 2.0 V	-	50	155	-	195	-	235	ns
		V <sub>CC</sub> = 4.5 V	-	18	31	-	39	-	47	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	40	ns
t <sub>PZL</sub>	OFF-state to LOW	OEn to I/On; see Fig. 9								
	propagation delay	V <sub>CC</sub> = 2.0 V	-	41	130	-	165	-	195	ns
		V <sub>CC</sub> = 4.5 V	-	15	26	-	33	-	39	ns
		V <sub>CC</sub> = 6.0 V	-	12	22	-	28	-	33	ns
t <sub>PHZ</sub>	HIGH to OFF-state	OEn to I/On; see Fig. 9	[5]							
	propagation delay	V <sub>CC</sub> = 2.0 V	-	66	185	-	230	-	280	ns
		V <sub>CC</sub> = 4.5 V	-	24	37	-	46	-	56	ns
		V <sub>CC</sub> = 6.0 V	-	19	31	-	39	-	48	ns
t <sub>PLZ</sub>	LOW to OFF-state	OEn to I/On; see Fig. 9								
	propagation delay	V <sub>CC</sub> = 2.0 V	-	55	155	-	195	-	235	ns
		V <sub>CC</sub> = 4.5 V	-	20	31	-	39	-	47	ns
		V <sub>CC</sub> = 6.0 V	-	16	26	-	33	-	40	ns
t <sub>rec</sub>	recovery time	MR to CP; see Fig. 7								
		V <sub>CC</sub> = 2.0 V	5	-14	-	5	-	5	-	ns
		V <sub>CC</sub> = 4.5 V	5	-5	-	5	-	5	-	ns
		V <sub>CC</sub> = 6.0 V	5	-4	-	5	-	5	-	ns
t <sub>su</sub>	set-up time	DSR, DSL to CP; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	100	33	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	12	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	10	-	21	-	26	-	ns
		S0, S1 to CP; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	100	33	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	12	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	10	-	21	-	26	-	ns
		I/On to CP; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	125	39	-	155	-	190	-	ns
		V <sub>CC</sub> = 4.5 V	25	14	-	31	-	38	-	ns
		V <sub>CC</sub> = 6.0 V	21	11	-	26	-	32	-	ns

#### 8-bit universal shift register; 3-state

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>h</sub>	hold time	I/On, DSR, DSL to CP; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	0	-14	-	0	-	0	-	ns
		V <sub>CC</sub> = 4.5 V	0	-5	-	0	-	0	-	ns
		V <sub>CC</sub> = 6.0 V	0	-4	-	0	-	0	-	ns
		S0, S1 to CP; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	0	-28	-	0	-	0	-	ns
		V <sub>CC</sub> = 4.5 V	0	-10	-	0	-	0	-	ns
		V <sub>CC</sub> = 6.0 V	0	-8	-	0	-	0	-	ns
f <sub>max</sub>	maximum frequency	CP input; see Fig. 6								
		V <sub>CC</sub> = 2.0 V	5.0	15	-	4.0	-	3.4	-	MHz
		V <sub>CC</sub> = 4.5 V	25	45	-	20	-	17	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	50	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	29	54	-	24	-	20	-	MHz

- [1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- [2]  $t_{pd}$  is the same as  $t_{PHL}$ .
- [3]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [4]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [5]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

#### 10.1. Waveforms and test circuit

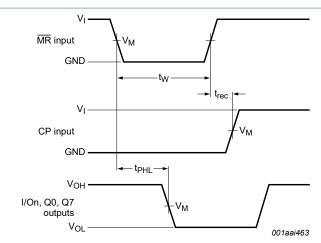


The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in <u>Table 8</u>.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 6. Clock pulse to outputs I/On, Q0, Q7 propagation delays, the clock pulse width, the I/On, DSR and DSL to clock pulse set-up and hold times, the output transition times and the maximum clock frequency

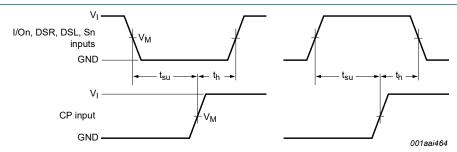
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Measurement points are given in Table 8.

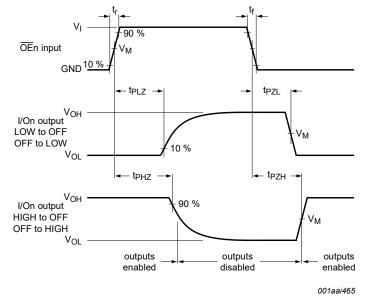
V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 7. The master reset pulse width (LOW), the master reset to outputs I/On, Q0, Q7 propagation delays and the master reset to clock pulse removal time



Measurement points are given in Table 8.

Fig. 8. Set-up and hold times from the mode control inputs S0, S1 to the clock pulse



Measurement points are given in Table 8.

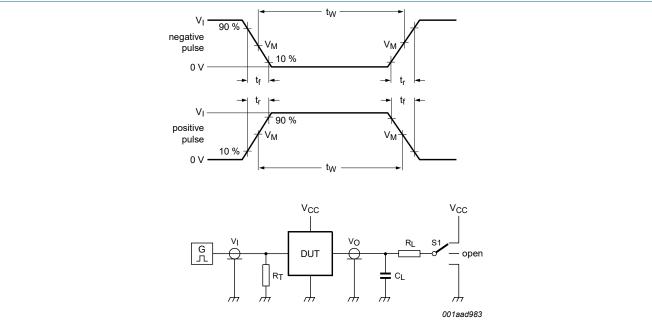
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig. 9. 3-state enable and disable times for OEn inputs

#### 8-bit universal shift register; 3-state

**Table 8. Measurement points** 

Input		Output
V <sub>I</sub>	V <sub>M</sub>	V <sub>M</sub>
V <sub>CC</sub>	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_L$  = Load resistance.

S1 = Test selection switch.

Fig. 10. Test circuit for measuring switching times

Table 9. Test data

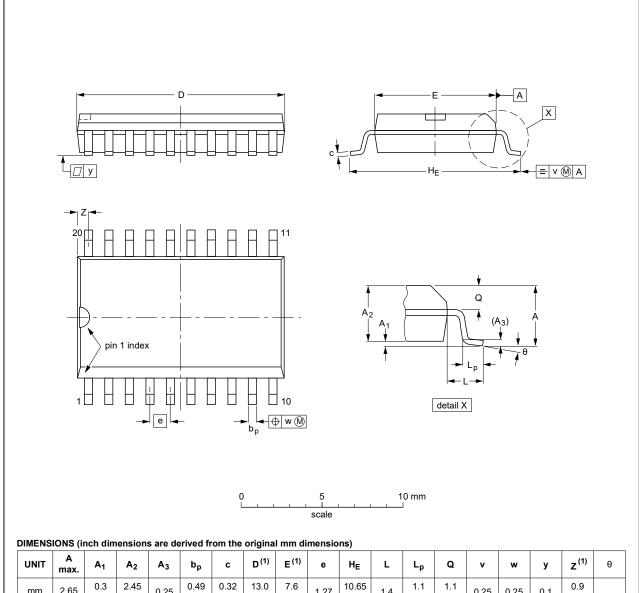
Input		Load		S1 position			
VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>		
V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	V <sub>CC</sub>		

8-bit universal shift register; 3-state

# 11. Package outline

#### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19	

Fig. 11. Package outline SOT163-1 (SO20)

8-bit universal shift register; 3-state

### 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

# 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes					
74HC299 v.6	20210511	Product data sheet	-	74HC299 v.5					
Modifications:		er 74HC299DB (SOT339-1 Derating values for P <sub>tot</sub> total		SSOP20) removed. power dissipation updated.					
74HC299 v.5	20190117 Product data sheet - 74HC299 v.4								
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74HC299PW (SOT360-1) removed.</li> </ul>								
74HC299 v.4	20160226	Product data sheet	-	74HC_HCT299 v.3					
Modifications:	<ul> <li>Type numbers 74HC299N and 74HCT299N (SOT146-1) removed.</li> <li>Type number 74HCT299D (SOT163-1) removed.</li> <li>Type number 74HCT299DB (SOT339-1) removed.</li> <li>Type number 74HCT299PW (SOT360-1) removed.</li> </ul>								
74HC_HCT299 v.3	20080728	Product data sheet	-	74HC_HCT299_CNV_2					
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 3: Ordering information added</li> <li>Section 12: Package outline drawings added</li> <li>Section 9 "Static characteristics": Family data added</li> <li>Section 11 "Waveforms": Test circuit added</li> </ul>								
74HC_HCT299_CNV v.2	19970828	Product specification	-	-					

#### 8-bit universal shift register; 3-state

### 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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74HC299

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### 8-bit universal shift register; 3-state

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